

IRK.26 SERIES

THYRISTOR/ DIODE and THYRISTOR/ THYRISTOR

NEWADD-A-pak™ Power Modules

Features

- Electrically isolated: DBC base plate
- 3500 V_{RMS} isolating voltage
- Standard JEDEC package
- Simplified mechanical designs, rapid assembly
- Auxiliary cathode terminals for wiring convenience
- High surge capability
- Wide choice of circuit configurations
- Large creepage distances
- UL E78996 approved 

27 A

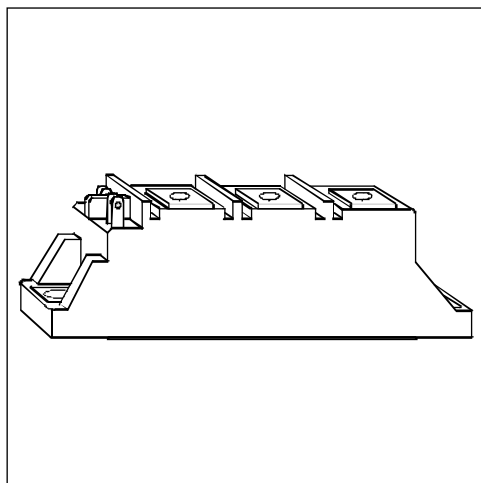
Description

These IRK series of NEW ADD-A-paks use power diodes and thyristors in a variety of circuit configurations. The semiconductor chips are electrically isolated from the base plate, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or AC controllers. These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, and temperature and motor speed control circuits.

Major Ratings and Characteristics

Parameters	IRK.26	Units
$I_{T(AV)}$ or $I_{F(AV)}$ @85°C	27	A
$I_{O(RMS)}$ (*)	60	A
I_{TSM} @50Hz	400	A
I_{FSM} @60Hz	420	A
I^2t @50Hz	800	A ² s
@60Hz	730	A ² s
$I^2\sqrt{t}$	8000	A ² √s
V_{RRM} range	400 to 1600	V
T_{STG}	-40 to 125	°C
T_J	-40 to 125	°C

(*) As AC switch.



IRK.26 Series

Bulletin I27130 rev. C 09/97

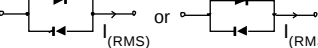
International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage	V_{RSM} , maximum non-repetitive peak reverse voltage	V_{DRM} , max. repetitive peak off-state voltage, gate open circuit	I_{RRM} , I_{DRM} 125°C
	-	V	V	V	mA
IRK.26	04	400	500	400	15
	06	600	700	600	
	08	800	900	800	
	10	1000	1100	1000	
	12	1200	1300	1200	
	14	1400	1500	1400	
	16	1600	1700	1600	

On-state Conduction

Parameters	IRK.26	Units	Conditions	
$I_{T(AV)}$ Max. average on-state current (Thyristors)	27	A	180° conduction, half sine wave, $T_C = 85^\circ\text{C}$	
$I_{F(AV)}$ Max. average forward current (Diodes)	27			
$I_{O(RMS)}$ Max. continuous RMS on-state current. As AC switch	60			
I_{TSM} Max. peak, one cycle or non-repetitive on-state or forward current	400		t=10ms No voltage	Sinusoidal half wave, Initial $T_J = T_J$ max.
	420		t=8.3ms reapplied	
	335		t=10ms 100% V_{RRM}	
	350		t=8.3ms reapplied	
	470		t=10ms $T_J = 25^\circ\text{C}$,	
	490		t=8.3ms no voltage reapplied	
I^2t Max. I^2t for fusing	800		A^2s	t=10ms No voltage
	730	t=8.3ms reapplied		
	560	t=10ms 100% V_{RRM}		
	510	t=8.3ms reapplied		
	1100	t=10ms $T_J = 25^\circ\text{C}$,		
	1000	t=8.3ms no voltage reapplied		
$I^2\sqrt{t}$ Max. $I^2\sqrt{t}$ for fusing (1)	8000	$\text{A}^2\sqrt{\text{s}}$	t=0.1 to 10ms, no voltage reappl. $T_J = T_J$ max.	
$V_{T(TO)}$ Max. value of threshold voltage (2)	0.92	V	Low level (3)	$T_J = T_J$ max
	0.95		High level (4)	
r_t Max. value of on-state slope resistance (2)	12.11	$\text{m}\Omega$	Low level (3)	$T_J = T_J$ max
	11.82		High level (4)	
V_{TM} Max. peak on-state or forward voltage	1.95	V	$I_{TM} = \pi \times I_{T(AV)}$	$T_J = 25^\circ\text{C}$
V_{FM}			$I_{FM} = \pi \times I_{F(AV)}$	
di/dt Max. non-repetitive rate of rise of turned on current	150	A/ μs	$T_J = 25^\circ\text{C}$, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_g = 500\text{mA}$, $t_r < 0.5 \mu\text{s}$, $t_p > 6 \mu\text{s}$	
I_H Max. holding current	200	mA	$T_J = 25^\circ\text{C}$, anode supply = 6V, resistive load, gate open circuit	
I_L Max. latching current	400		$T_J = 25^\circ\text{C}$, anode supply = 6V, resistive load	

- (1) I^2t for time $t_x = I^2\sqrt{t} \times \sqrt{t_x}$ (2) Average power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$ (3) $16.7\% \times \pi \times I_{AV} < I < \pi \times I_{AV}$
(4) $I > \pi \times I_{AV}$

Triggering

Parameters	IRK.26	Units	Conditions
P_{GM} Max. peak gate power	10	W	
$P_{G(AV)}$ Max. average gate power	2.5		
I_{GM} Max. peak gate current	2.5	A	
$-V_{GM}$ Max. peak negative gate voltage	10	V	Anode supply = 6V resistive load
V_{GT} Max. gate voltage required to trigger	4.0		
	2.5		
	1.7		
I_{GT} Max. gate current required to trigger	270	mA	Anode supply = 6V resistive load
	150		
	80		
V_{GD} Max. gate voltage that will not trigger	0.25	V	$T_J = 125^\circ\text{C}$, rated V_{DRM} applied
I_{GD} Max. gate current that will not trigger	6	mA	$T_J = 125^\circ\text{C}$, rated V_{DRM} applied

Blocking

Parameters	IRK.26	Units	Conditions
I_{RRM} Max. peak reverse and off-state leakage current at V_{RRM} , V_{DRM}	15	mA	$T_J = 125^\circ\text{C}$, gate open circuit
V_{INS} RMS isolation voltage	2500 (1 min) 3500 (1 sec)	V	50 Hz, circuit to base, all terminals shorted
dv/dt Max. critical rate of rise of off-state voltage (5)	500	V/ μs	$T_J = 125^\circ\text{C}$, linear to $0.67 V_{DRM}$, gate open circuit

(5) Available with $dv/dt = 1000\text{V}/\mu\text{s}$, to complete code add S90 i.e. IRKT26/16 S90.

Thermal and Mechanical Specifications

Parameters	IRK.26	Units	Conditions
T_J Junction operating temperature range	- 40 to 125	$^\circ\text{C}$	
T_{stg} Storage temp. range	- 40 to 125		
R_{thJC} Max. internal thermal resistance, junction to case	0.31	K/W	Per module, DC operation
R_{thCS} Typical thermal resistance case to heatsink	0.1		Mounting surface flat, smooth and greased. Flatness < 0.03 mm; roughness < 0.02 mm
T Mounting torque $\pm 10\%$ to heatsink busbar	5	Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound
	3		
wt Approximate weight	83 (3)	g (oz)	
Case style	TO-240AA		JEDEC

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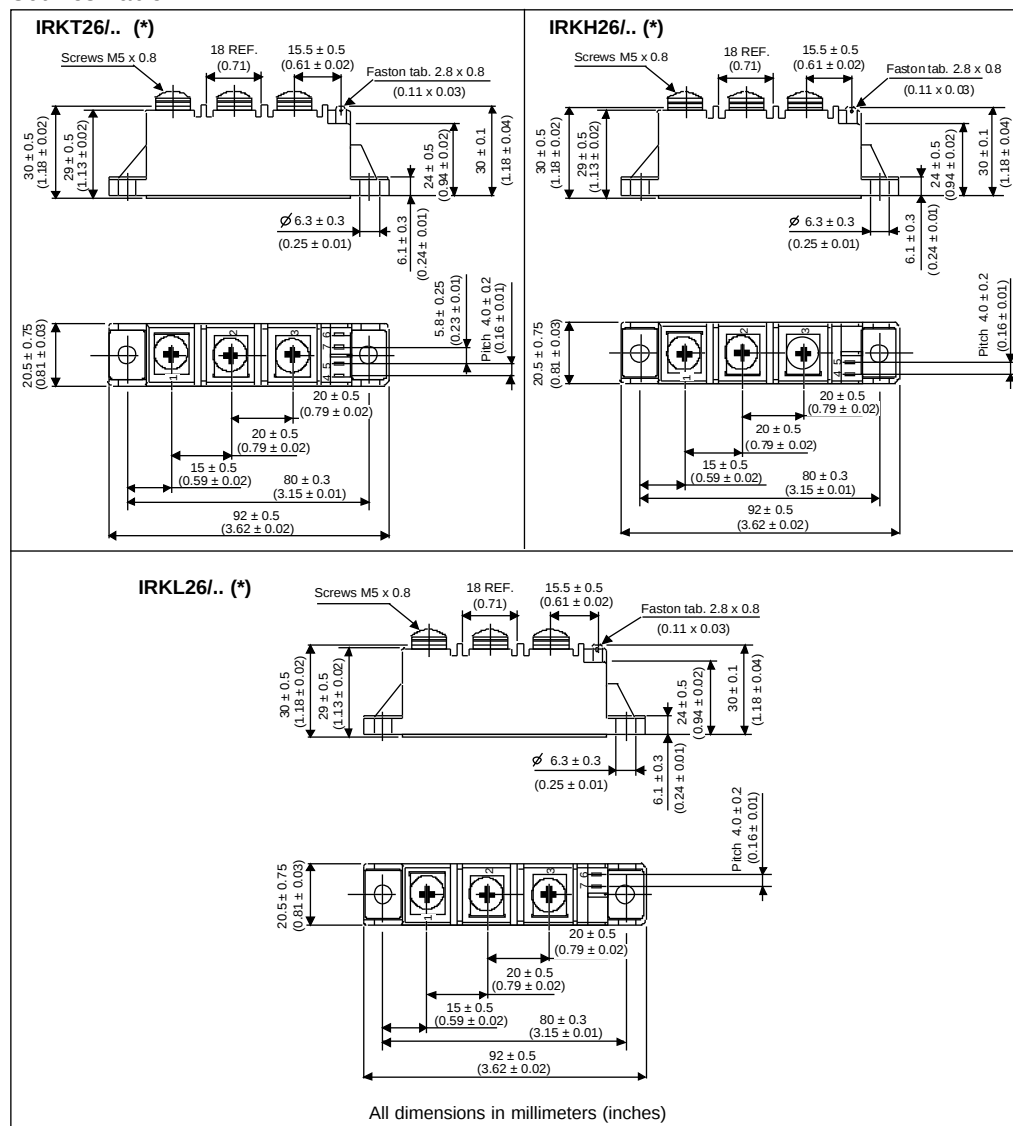
International
IR Rectifier

ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Devices	Sine half wave conduction					Rect. wave conduction					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
IRK.26	0.23	0.27	0.34	0.48	0.73	0.17	0.28	0.36	0.49	0.73	°C/W

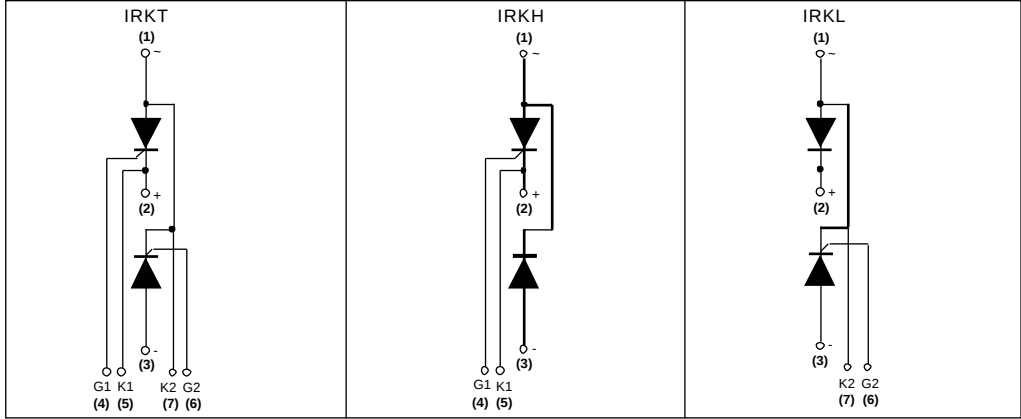
Outlines Table



(*) For terminals connections, see Circuit configurations Table

NOTE: To order the Optional Hardware see Bulletin I27900

Circuit Configurations Table



Ordering Information Table

Device Code

IRK	T	26	/	16	S90
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1 2 3 4 5

IRK.27 types
With no auxiliary cathode

1 - Module type
2 - Circuit configuration (See Circuit Configuration table)
3 - Current code**
4 - Voltage code (See Voltage Ratings table)
5 - dv/dt code: S90 = dv/dt 1000 V/μs
No letter = dv/dt 500 V/μs

** Available with no auxiliary cathode.
To specify change: 26 to 27
e.g. : IRKT27/16 etc.

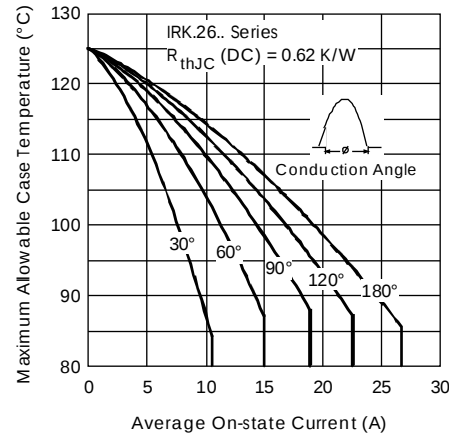


Fig. 1 - Current Ratings Characteristics

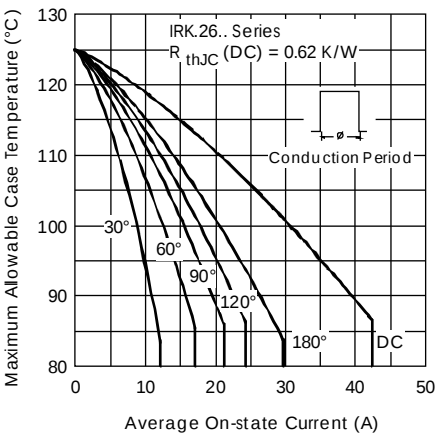


Fig. 2 - Current Ratings Characteristics

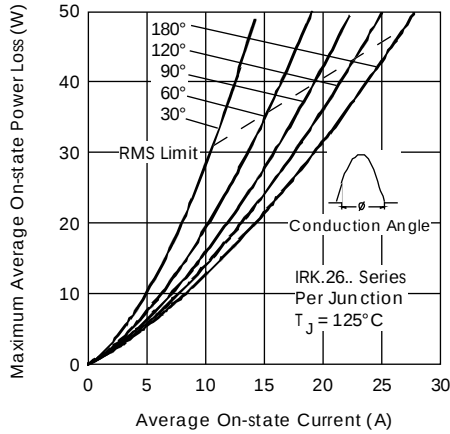


Fig. 3 - On-state Power Loss Characteristics

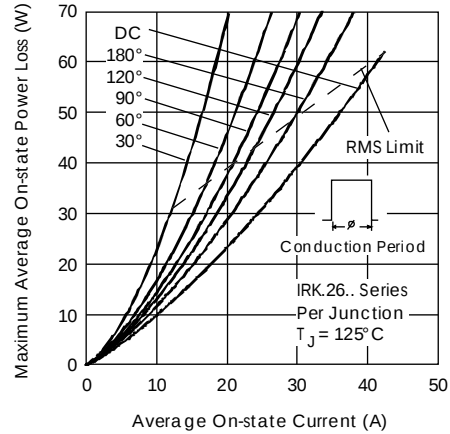


Fig. 4 - On-state Power Loss Characteristics

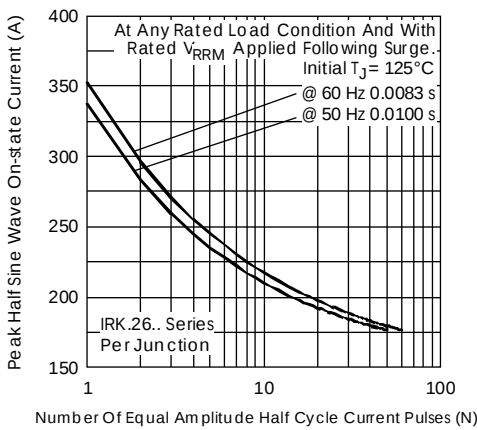


Fig. 5 - Maximum Non-Repetitive Surge Current

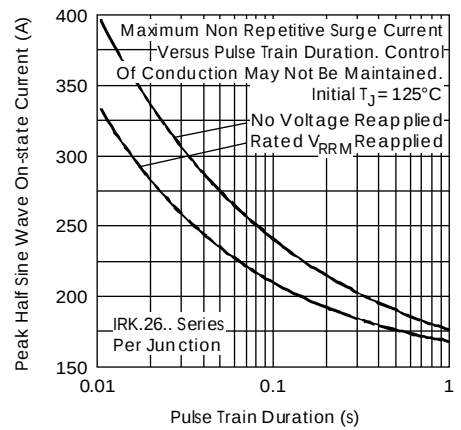


Fig. 6 - Maximum Non-Repetitive Surge Current

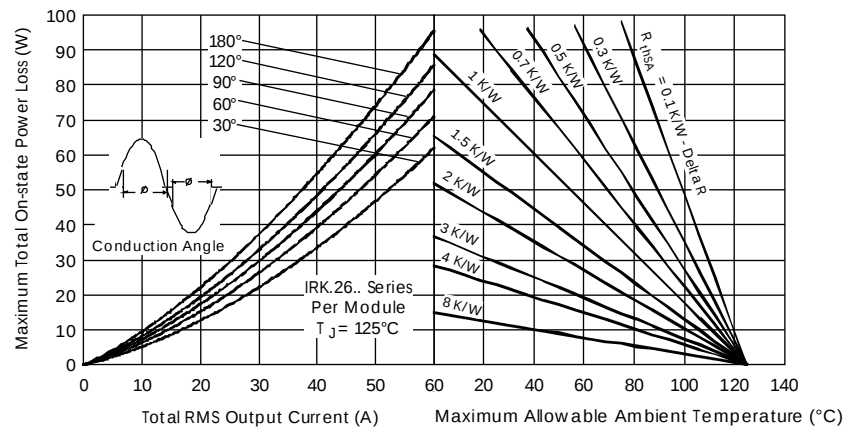


Fig. 7 - On-state Power Loss Characteristics

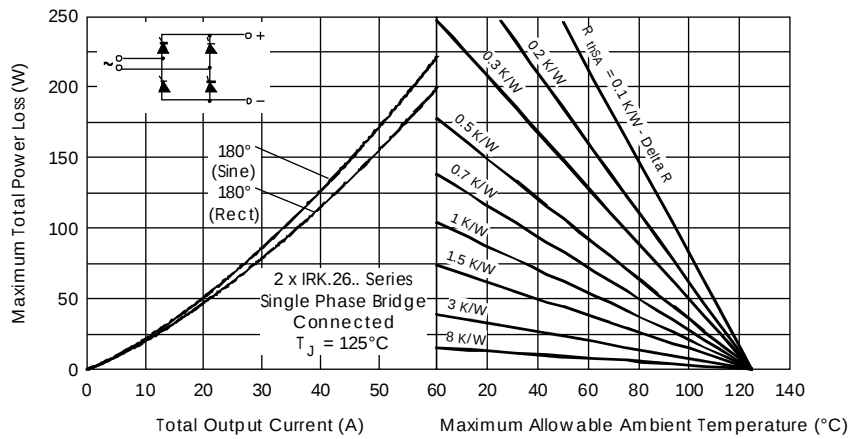


Fig. 8 - On-state Power Loss Characteristics

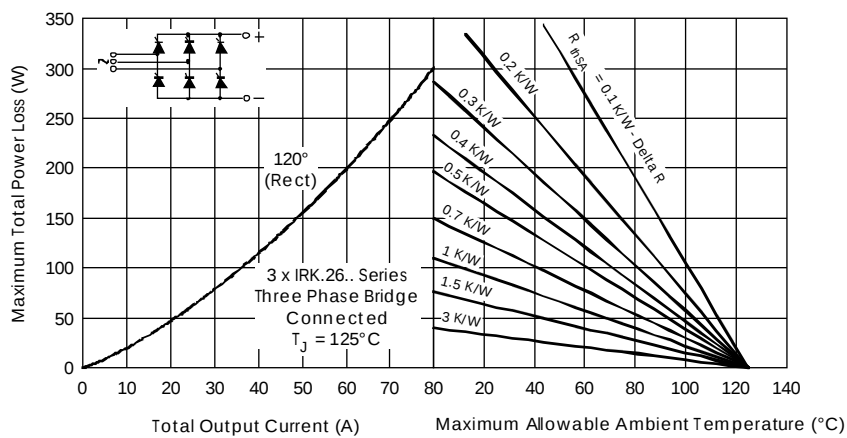


Fig. 9 - On-state Power Loss Characteristics

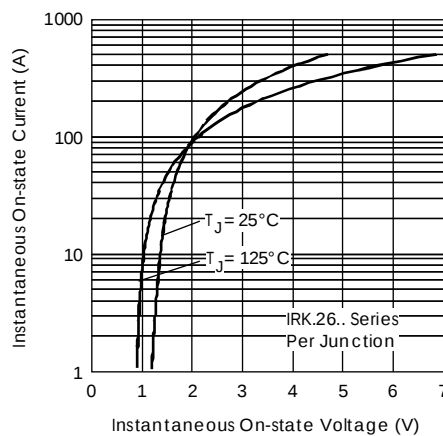


Fig. 10 - On-state Voltage Drop Characteristics

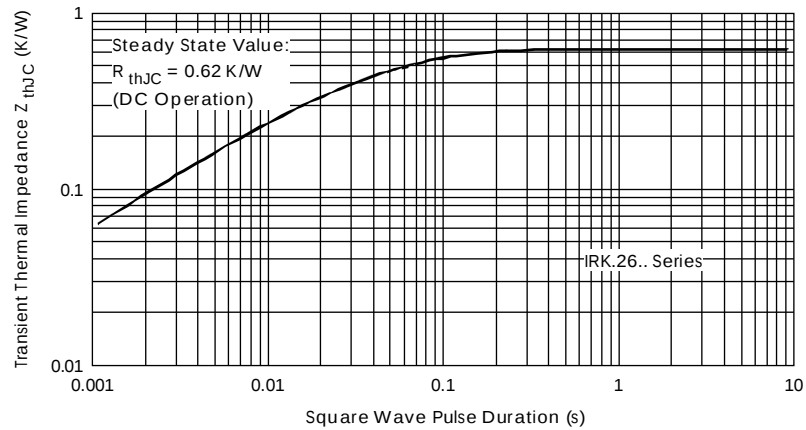


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics

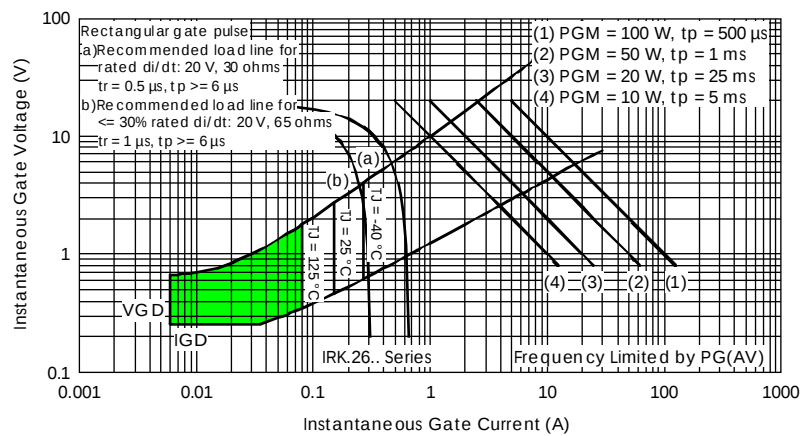


Fig. 12- Gate Characteristics